SCOPE:

This specification applies to the Pb Free high current type SMD inductors for MSCDB-1305H-SERIES

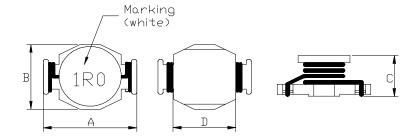
Warn: It is here not to use synchronous rectification curcuit!

PRODUCT INDENTIFICATION

MSCDB - 1305H - 1R0 M

- 1
- 2
- 3 4
- 1 Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 13.20Max. mm
B: 9.95 Max. mm
C: 6.35 Max. mm
D: 9.60 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60°C Max.
- (3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent			Marking		
PT/NO.	L(µH)	Tolerance	Frequency RDC(Ω)M		IDC(A)		
MSCDB-1305H-R33	0.33	N	100kHz/0.25V	2m	16.0	R33	
MSCDB-1305H-R47□	0.47	N	100kHz/0.25V	5m	10.6	R47	
MSCDB-1305H-1R0□	1.0	M,N	100kHz/0.25V	6m	10.0	1R0	
MSCDB-1305H-1R5□	1.5	M,N	100kHz/0.25V	8m	9.00	1R5	
MSCDB-1305H-2R2□	2.2	M,N	100kHz/0.25V	11m	7.40	2R2	
MSCDB-1305H-2R7□	2.7	M,N	100kHz/0.25V	12m	6.60	2R7	
MSCDB-1305H-3R3□	3.3	M,N	100kHz/0.25V	14m	5.90	3R3	
MSCDB-1305H-3R9□	3.9	M,N	100kHz/0.25V	15m	5.30	3R9	
MSCDB-1305H-4R7□	4.7	M,N	100kHz/0.25V	18m	4.80	4R7	
MSCDB-1305H-6R8□	6.8	M,N	100kHz/0.25V	23m	4.50	6R8	
MSCDB-1305H-100□	10	M,N	100kHz/0.25V	30m	4.30	100	
MSCDB-1305H-150	15	M,N	100kHz/0.25V	45m	3.60	150	
MSCDB-1305H-220	22	M,N	100kHz/0.25V	64m	2.90	220	
MSCDB-1305H-330	33	M,N	100kHz/0.25V	99m	2.40	330	
MSCDB-1305H-470□	47	M,N	100kHz/0.25V	0.146	1.90	470	
MSCDB-1305H-680□	68	M,N	100kHz/0.25V	0.190	1.70	680	
MSCDB-1305H-820□	82	M,N	100kHz/0.25V	0.268	1.50	820	
MSCDB-1305H-101□	100	M,N	100kHz/0.25V	0.277	1.40	101	
MSCDB-1305H-151	150	M,N	100kHz/0.25V	0.424	1.10	151	
MSCDB-1305H-221	220	M,N	100kHz/0.25V	0.636	0.93	221	
MSCDB-1305H-331□	330	M,N	100kHz/0.25V	0.977	0.76	331	

※ □ specify the inductance tolerance,M(±20%),N(±30%)

%IDC : Based on inductance change (\triangle L/Lo : drop 10% Max.) @ ambient temp. 25 $^{\circ}$ C and

Based on temperature rise ($\triangle T$: 40°C TYP.)



(4) RELIABILITY TEST METHOD MECHANICAL

SPECIFICATION	TEST DETAILS			
∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
	in figure 1 and a load applied unitil the figure in the arrow			
There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
no mechanical	PCB dimension shall the page 7/9			
damage or elec-	F(Pressurization)			
trical damege.	П			
	R5 45±2 45±2 20 10 R340			
	PRESSURE ROD figure-1			
∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
	and when a vibration having an amplitude of 1.52mm			
There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
damage.	(A total of 6 hours)			
New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
More than 90%	over the whole of the sample before hard, the sample shall			
	then be preheated for about 2 minutes in a temperature of			
	130~150℃ and after it has been immersed to a depth 0.5mm			
	below for 3±0.2 seconds fully in molten solder M705 with			
	a temperature of 245±5℃.			
	More than 90% of the electrode sections shall be couered			
	with new solder smoothly when the sample is taken out of			
	the solder bath.			
	△L/Lo≤±5% There shall be no mechanical damage or electrical damege. △L/Lo≤±5% There shall be no mechanical damage.			



MECHANICAL

TEST ITEM		SPECIFICATION						
TEST ITEM Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3°C 10 sec Pre-heating 150 Pre-heating Slow cooling (Stored at room temperature) 2 min or mare The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.						
		The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.						

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top			
withstand	no other	surface and the terminal of this sample			
voltage	damage or				
	problems.				
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in			
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!$			
		calculated based on the value applicable in a normal			
		temperature and narmal humidity shall be \triangle L/L20 $^{\circ}$ C \leq ±10%.			

ENVIROMENT CHARACTERISTICS

TEST ITEM		SPECIFICATION					
High temperature	∆L/Lo≦±5%	The samp	The sample shall be left for 96±4 hours in an atmospere with				
storage		a tempera	a temperature of 85±2℃ and a normal humidity.				
	There shall be	Upon con	Upon completion of the measurement shall be made after the				
	no mechanical	sample ha	sample has been left in a normal temperature and normal				
	damage.	humidity	humidity for 1 hour.				
Low temperature	∆L/Lo≦±5%	The samp	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a tempera	a temperature of -25±3℃.				
	There shall be	Upon con	Upon completion of the test, the measurement shall be made				
	no mechanical	after the s	samp	ole has been left in a no	rmal temperature and		
	damage.	normal hu	umid	ity for 1 hour.			
Change of	∆L/Lo≦±5%	The samp	The sample shall be subject to 5 continuos cycles, such as shown				
temperature		in the tab	in the table 2 below and then it shall be subjected to standard				
	There shall be	atmosphe	eric c	onditions for 1 hour, af	ter which measureme	nt	
	no other dama-	shall be n	shall be made.				
	ge of problems						
			table 2				
				Temperature	Duration		
			1	−25±3° C	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	85±2 ℃	30 min.		
			(Themostat No.2)				
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of					
		$40\pm2\%$ and a humidity(RH) of $90\sim95\%$.					
	There shall be	ere shall be Upon completion of the test, the measurement shall be made mechanical after the sample has been left in a normal temperature and					
	no mechanical						
	damage.						
Test conditions :		I		<u>-</u>			
	sample shall be reflo	w soldered o	onto	the printed circuit boar	d in every test.		

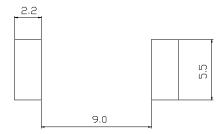


(5) LAND DIMENSION (Ref.)

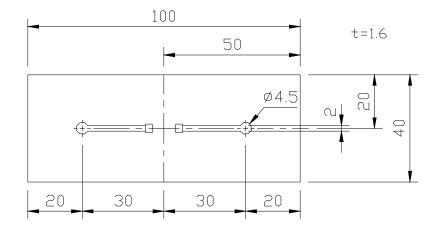
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm



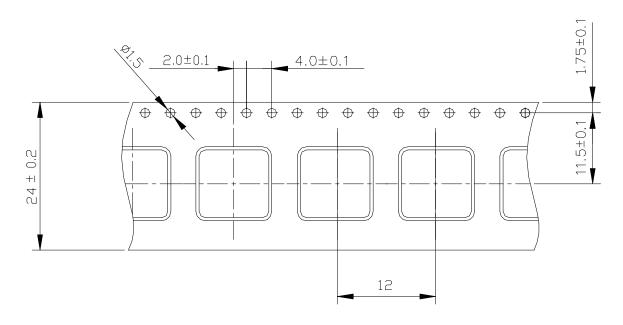
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



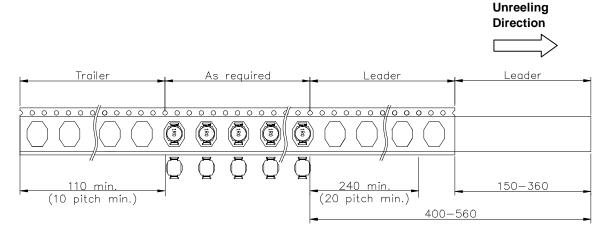


(6) PACKAGING

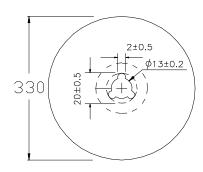
(6)-1 CARRIER TAPE DIMENSIONS (mm)

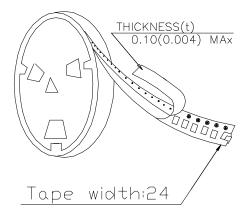


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

700pcs/Reel

The products are packaged so that no damage will be sustained.